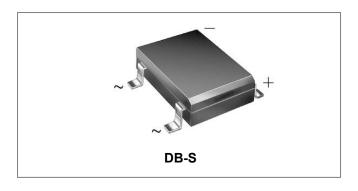




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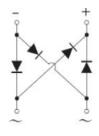
DB201S THRU DB207S SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIERS



Features

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: DB-S, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting position: Any
- Lead Free: For RoHS / Lead Free Version,

Maximum Ratings@T_A=25°C unless otherwise specified

Single Phase half wave 60Hz, resistive or inductive load. For capacitive load current derate by 20%.

Characteristic	Symbol	DB 201S	DB 202S	DB 203S	DB 204S	DB 205S	DB 206S	DB 207S	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	v
RMS Reverse Voltage	VRMS	35	70	140	280	420	560	700	V
Average Forward Output Current (Note 1) @ $T_A = 40^{\circ}C$	I _{F(AV)}				2.0		I		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	60					A		

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DB201S THRU DB207S

Electrical Characteristics:

RoHS 🗭

Characteristic	Symbol	DB 201S	DB 202S	DB 203S	DB 204S	DB 205S	DB 206S	DB 207S	Unit
Maximum Forward Voltage Drop per Bridge Element $@I_F = 2.0A, T_A = 25^{\circ}C$	VF				1.1				V
Peak Reverse Current $@T_A = 25^{\circ}C$ At Rated DC Blocking Voltage $@T_A = 125^{\circ}C$	I _R				5 500				μA
Typical Junction Capacitance (Note 2)	CJ	CJ 25			pF				

* Pulse width < 300 μ s, duty cycle < 2%

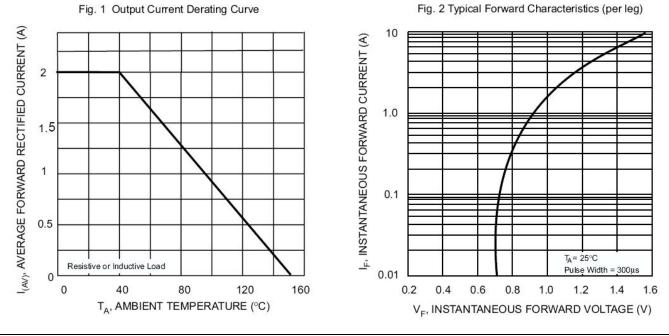
Thermal-Mechanical Specifications:

Characteristic	Symbol	DB 201S	DB 202S	DB 203S	DB 204S	DB 205S	DB 206S	DB 207S	Unit
Typical Thermal Resistance Junction to Ambient	R _{0JA}	ја 40				°C/W			
Typical Thermal Resistance Junction to Lead	R _{θJL}	15						°C/W	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55+150			°C				

Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad.

2. Measured at 1.0 MHZ and applied reverse voltage of 4.0 VDC

Ratings and Characteristics Curves



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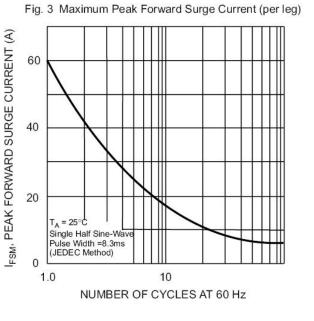


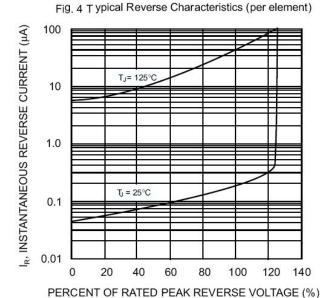
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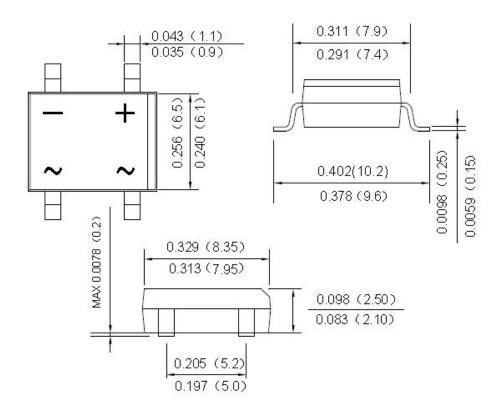
RoHS

Technical Data Data Sheet N1941, Rev. -





Mechanical Dimensions DB-S(Inches/Millimeters)



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Technical Data Data Sheet N1941, Rev. -

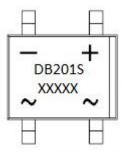
RoHS 🗭

Ordering Information

Device	Package	Plating	Shipping
DB201S THRU DB207S	DB-S (Pb-Free)	Pure Sn	1500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

- DB201S = Type Num
 - = Type Number = Year

YY WW

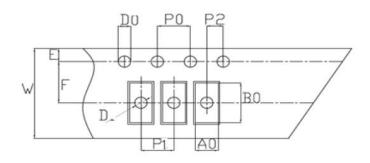
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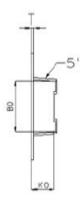
= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Carrier Tape Specification DB-S





SYMBOL	Millimeters					
STMBOL	Min.	Max.				
A0	8.65	8.95				
B0	10.31	10.51				
D0	1.50	1.60				
D1	1.40	1.60				
P0	3.90	4.10				
P1	11.90	12.10				
P2	1.90	2.10				
E	1.65	1.85				
K0	3.21	3.41				
F	7.40	7.60				
W	15.70	16.30				
Т	0.30	0.40				
10P0	39.80	40.20				



Technical Data Data Sheet N1941, Rev. -

DB201S THRU DB207S



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2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.

3- In no event shall SMC Diode Solutions be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). SMC Diode Solution assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.
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